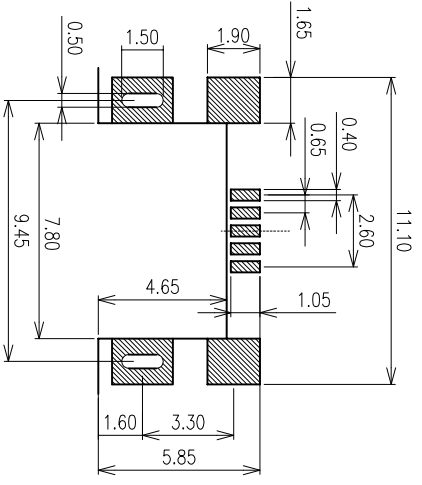
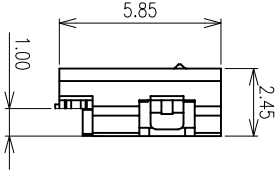
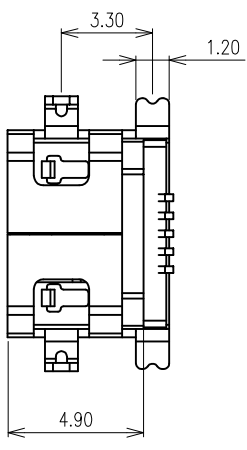
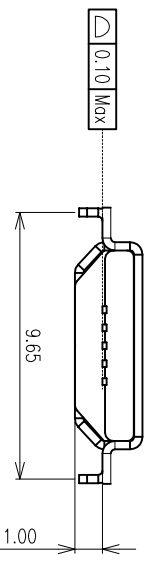
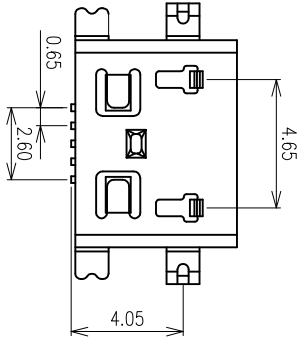
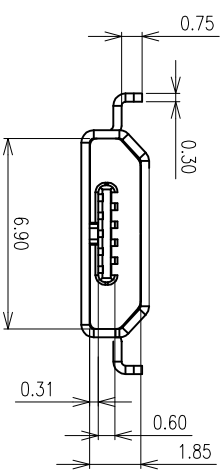


REV	EON #	DESCRIPTION	DRAWING	APPROVED	DATE
A		NEW RELEASE	DEY1		2012.06.28



RECOMMENDED PCB LAYOUT(TOP VIEW)
GENERAL TOLERANCES:±0.05

- NOTES:
- MATERIAL:
 - HOUSING: THERMOPLASTIC FLAMMABILITY RATING UL94V-0
 - CONTACT: COPPER ALLOY T=0.15mm
 - SHELL: STAINLESS STEEL T=0.30mm
 - FINISH:
 - CONTACT:
 - Min. PLATED ON CONTACT AREA
 - PLATING ON SOLDER TAIL AREA
 - SHELL:
 - 50~80μ" NICKEL UNDERPLATING OVERALL
 - 80~120 μ" MATTER TIN PLATING ALL
 - 50~80μ" NICKEL UNDERPLATING OVERALL
 - SPECIFICATION:
 - CURRENT RATING: 0.5A(2.3A CONTACT)/1.8A(1.5CONTACT) MAX.
 - VOLTAGE: 30 VAC
 - TEMPERATURE RANGE: -30 °C ~ 85 °C
 - CONTACT RESISTANCE: 30 MILLIONHM MAX.
 - DIELECTRIC WITHSTANDING VOLTAGE: 250 VAC r.m.s
 - INSULATION RESISTANCE: 100 MEGOHMS MIN

- PRODUCT NO.
- MU08 - 05 A B 03 - 03
- ① 产品系列: MU08: MICRO USB 连接器
 - ② 产品PIN数: 05: 5PIN
 - ③ 材质: A: LCP
 - ④ 产品流水码: 03: 外壳前插后贴无翻边,沉板1.0mm

CUSTOMER DRAWING		YTCONN <small>http://www.ytconn.com</small>		Dongguan YTCOONN Electronics Technology Co., Ltd	
GENERAL TOLERANCE	DRAWING	DEV1	TITLE:	MICRO USB 5P 沉板1.0 前插后贴无翻边	
X ±0.20	APPROVED		P/N:	MU08-05AB03-03	
XX ±0.15	DATE	2013. 12. 28	DRAWING NO.	C-MU08-03	
XXX ±0.10	UNIT	mm	SCALE	1:1	SIZE A4
ANGEL TOLERANCE			SHEET	1of1	SHEET 1of1
X ±3°					REV A
XX ±2°					
XXX ±1°					